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Custom Display

Production Custom designs Installation

Mechanical design



MODEL NO : ET013QV03-TT

MODEL VERSION: 01

SPEC VERSION : 1.0

ISSUED DATE: 2022-11-23

☐ Preliminary Specification

☒ Final Product Specification

Customer : _____

Approved by	Notes

Youri Confirmation

Prepared by	Reviewed by	Approved by
John	Johnny	Wang

1. Introduction

1.1 Scope of application

LCD specification: Dots 240xRGBx240.

As to basic specification of the driver IC, refer to the IC (GC9A01) specification and data book.

All material & processing of the LCD module should be Lead Free.

1.2 TFT features:

Structure: TFT PANNEL+IC +FPC+BL;

IPS Type LCD

240dot-segment and 240 dot-common outputs;

65K/262K Color can be selected by software;

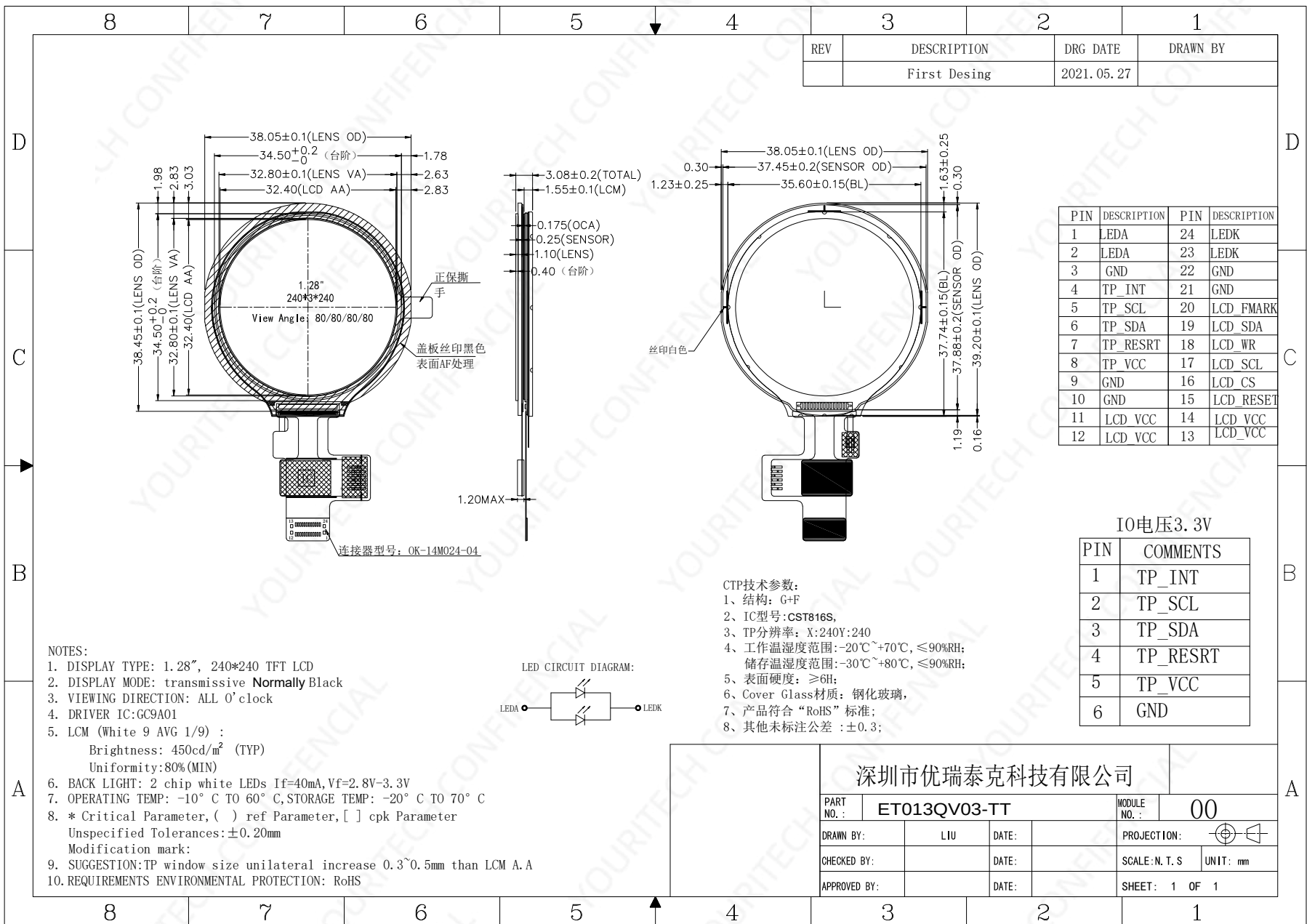
White LED back light;

4line SPI interface

1.3 Applications:

2. LCM General specification

ITEM	Standard value	Unit
LCD Type	Normally black	--
Drive element	TFT active matrix	--
Number of pixels	240(H) RGB × 240(V)	Dots
Pixel arrangement	RGB Vertical Stripe	--
Pixel Pitch (H*V)	0.135(H) × 0.135(V)	mm
Active area	32.40(H) × 32.40(V)	mm
Viewing direction	ALL O'CLOCK	--
TFT Driver IC	GC9A01	--
TFT interface	4line SPI interface	--
Approx. Weight	TBD	g
LCM Size(W*H*T)	35.60(W) × 37.74(H) × 1.55(T)	mm
Touch structure	--	--
Touch Driver IC	--	--
Touch Interface	--	--



3.Absolute Maximum Rating

Characteristics	Symbol	Min.	Max.	Unit
LCM Operating Temperature	T _{OPR}	-10	+60	°C
LCM Storage Temperature	T _{STG}	-20	+70	°C
Humidity	RH	--	90	%

4.Electrical Characteristics

4.1 TFT DC Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Note
Supply Voltage for(DC/DC)	VDD	2.5	2.8	3.3	V	
TFT Gate ON Voltage	VGH	--	--	--	--	
TFT Gate OFF Voltage	VGL	--	--	--	--	
TFT Common Voltage	Vcom	--	--	--	--	

4.2 Back-Light Unit Characeristics

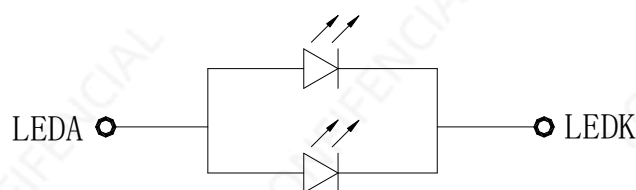
The back-light system is an edge-lighting type with 2 white LEDs. The characteristics of the back-light are shown in the following tables.

Characteristics	Symbol	Min.	Type	Max.	Unit	Notes
Forward Voltage	V _F	2.8	--	3.3	V	--
Forward current	I _F	--	40	--	mA	--
Luminance(With LCD)	L _v	--	450	--	cd/m ²	--
LED life time	N/A	--	30,000	--	Hr	Note 1

Note:

- (1) The “LED life time” is defined as the module brightness decrease to 50% of original brightness at I_L=20mA/LED. The LED life time could be decreased if operating I_L is larger than 25mA/LED.

Backlight circuit diagram shown in below:



5. Module Function Description

Pin No.	Symbol	LCM Description	remarks
1-2	LEDA	Power supply for backlight anode input terminal.	
3	GND	Ground	
4	CTP_INT	Touch panel interrupt output	
5	CTP_SCL	Touch panel I2C clock	
6	CTP_SDA	Touch panel I2C data	
7	CTP_RST	Touch panel reset	
8	CTP_VCC	Touch panel Power supply 2.8~3.3V	
9-10	GND	Ground	
11-14	LCD-VCC	Power supply : 2.5V ~ 3.3V	
15	LCD-RESET	Global reset pin	
16	LCD-CS	Chip select signal input pin	
17	LCD-SCL	Synchronous clock signal pin	
18	LCD-RS	Register selection signal.	
19	LCD-SDA	input/output signal pin	
20	LCD-LPTE	Frame head pulse for tearing effect.	
21-22	GND	Ground	
23-24	LEDK	Power supply for backlight cathode input terminal.	

6. Timing Characteristics

Display Serial Interface Timing Characteristics (4-line SPI system)

Figure98.

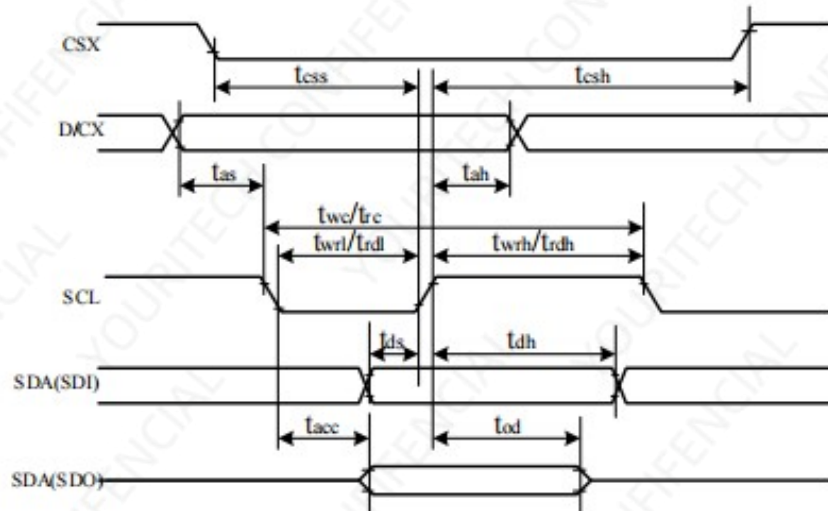
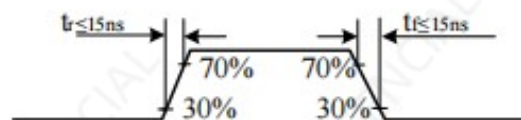


Table48.

Signal	Symbol	Parameter	min	max	Unit	Description
CSX	t_{css}	Chip select time (Write)	20	-	ns	
	t_{csh}	Chip select hold time (Read)	40	-	ns	
SCL	t_{we}	Serial Clock Cycle (Write)	10	-	ns	
	t_{wrh}	SCL "H" Pulse Width (Write)	5	-	ns	
	t_{wrl}	SCL "L" Pulse Width (Write)	5	-	ns	
	t_{re}	Serial Clock Cycle (Read)	150	-	ns	
	t_{rdh}	SCL "H" Pulse Width (Read)	60	-	ns	
	t_{rdl}	SCL "L" Pulse Width (Read)	60	-	ns	
D/CX	t_{as}	D/CX setup time	10	-	ns	
	t_{ah}	D/CX hold time (Write/Read)	10	-	ns	
SDA/SDI (Input)	t_{ds}	Data setup time (Write)	5	-	ns	
	t_{dh}	Data hold time (Write)	5	-	ns	
SDA/SDO (Output)	t_{acc}	Access time (Read)	10	-	ns	

Note: $T_a = 25^\circ\text{C}$, $IOVCC = 1.65\text{V to } 3.3\text{V}$, $VCI = 2.5\text{V to } 3.3\text{V}$, $AGND = VSS = 0\text{V}$

Figure99.



Reset Timing:

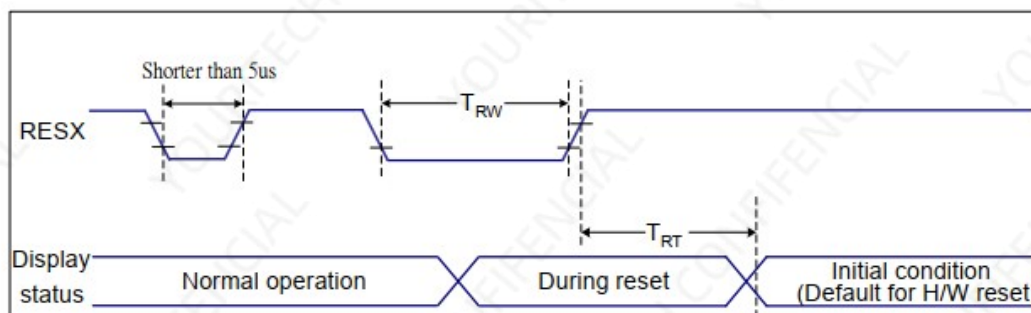


Figure 7 Reset Timing

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=25 °C

Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5) 120 (Note 1, 6, 7)	ms

Table 9 Reset Timing

Notes:

1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.

4. Spike Rejection also applies during a valid reset pulse as shown below:



5. When Reset applied during Sleep In Mode.
6. When Reset applied during Sleep Out Mode.
7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

7.Optical Characteristics

Optical Specification

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Note
Transmittance (with Polarizer)		T (%)	Θ=0 Normal viewing angle	(4.4)	(4.9)	—	%	Measuring with normal polarizer , Reference Only Base on Vop=5.1V
Transmittance (without Polarizer)		T (%)		(13.5)	(15.0)	—	%	
Contrast Ratio		CR		900	1100	—	—	(1)(2)
Response Time		T _R +T _F		—	30	35	msec	(1)(3)
Color Gamut	(%)			55	60	—	%	C-light
Color Chromaticity (CIE1931)	White	W _x		-0.02	(0.324)	+0.02	—	(1)(4) CF glass C-light
		W _y			(0.347)			
	Red	R _x			(0.644)		—	
		R _y			(0.333)			
	Green	G _x			(0.325)		—	
		G _y	(0.566)					
	Blue	B _x	(0.134)		—			
		B _y	(0.124)					
Viewing Angle	Hor.	Θ _L	CR> 10	80	85	—	—	(1)(4) Measuring with normal polarizer , Reference Only
		Θ _R		80	85	—		
	Ver.	Θ _U		80	85	—		
		Θ _D		80	85	—		
Optima View Direction		Free						(5)

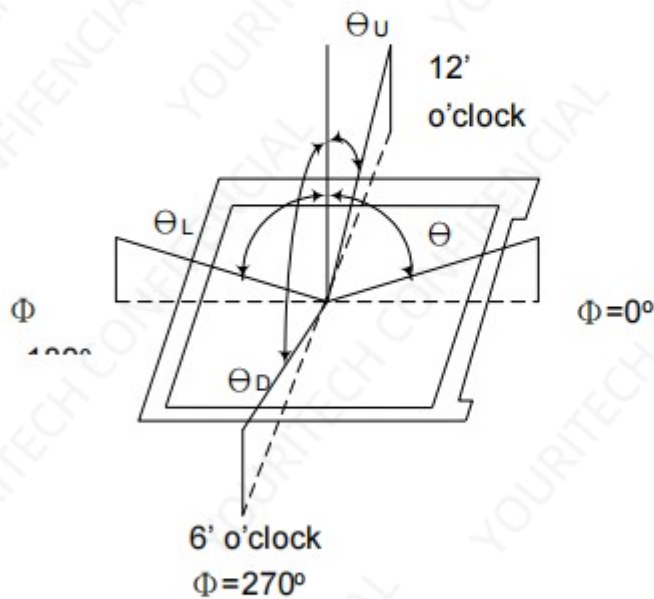
Measuring Condition

- Measuring surrounding : dark room
- Ambient temperature : $25 \pm 2^\circ\text{C}$
- 15min. warm-up time.

Measuring Equipment

- FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.

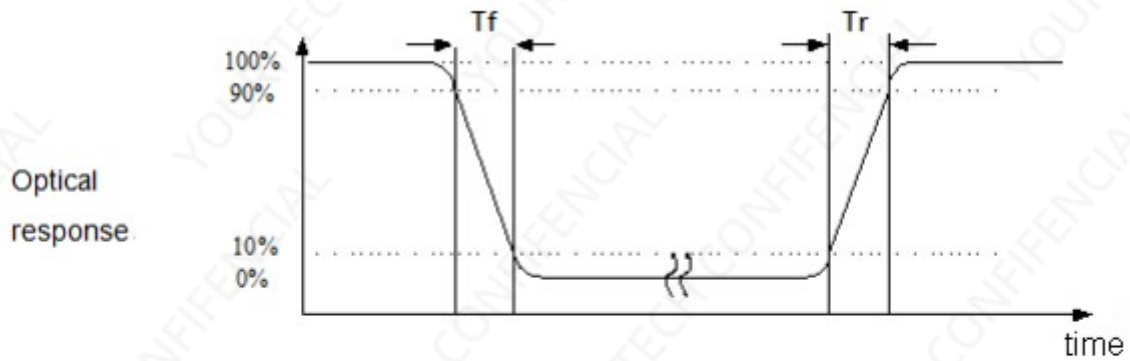
Note (1) Definition of Viewing Angle:



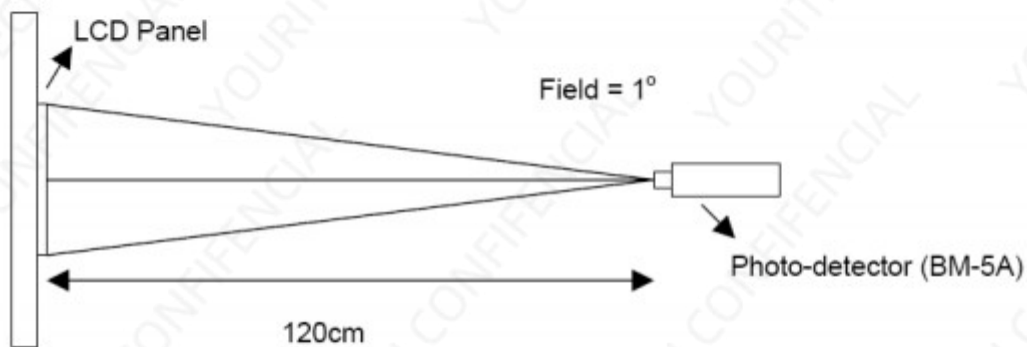
Note (2) Definition of Contrast Ratio (CR) :
measured at the center point of panel

$$\text{CR} = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

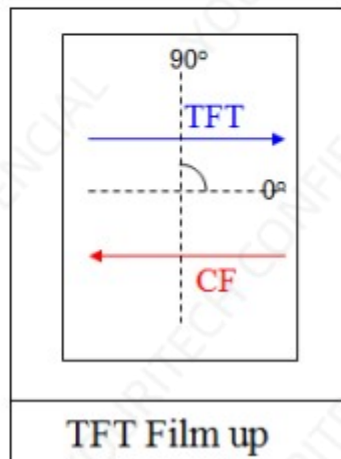
Note (3) Definition of Response Time : Sum of T_R and T_F



Note (4) Definition of optical measurement setup



Note (5) Rubbing Direction (The different Rubbing Direction will cause the different optima view direction.)



8. Reliability Test Item

No.	Test Item	Test Condition	Notes
1	High Temp. Storage	+70°C / 96H	1. Functional test is OK. Missing Segment, short, unclear segment non-display, display abnormally and liquid crystal leakage un-allowed. 2. No low temperature bubbles, end seal loose and fall, frame rainbow.
2	Low Temp. Storage	-20°C / 96H	
3	High Temp. Operating	+60°C / 96H	
4	Low Temp. Operating	-10°C / 96H	
5	High Temperature / Humidity storage	50°C x 90%RH / 96H	
6	Thermal and cold shock	Static state, -30°C (30min) ~60°C (30min), 50 cycles	

9. Packing Method----TBD

- END -